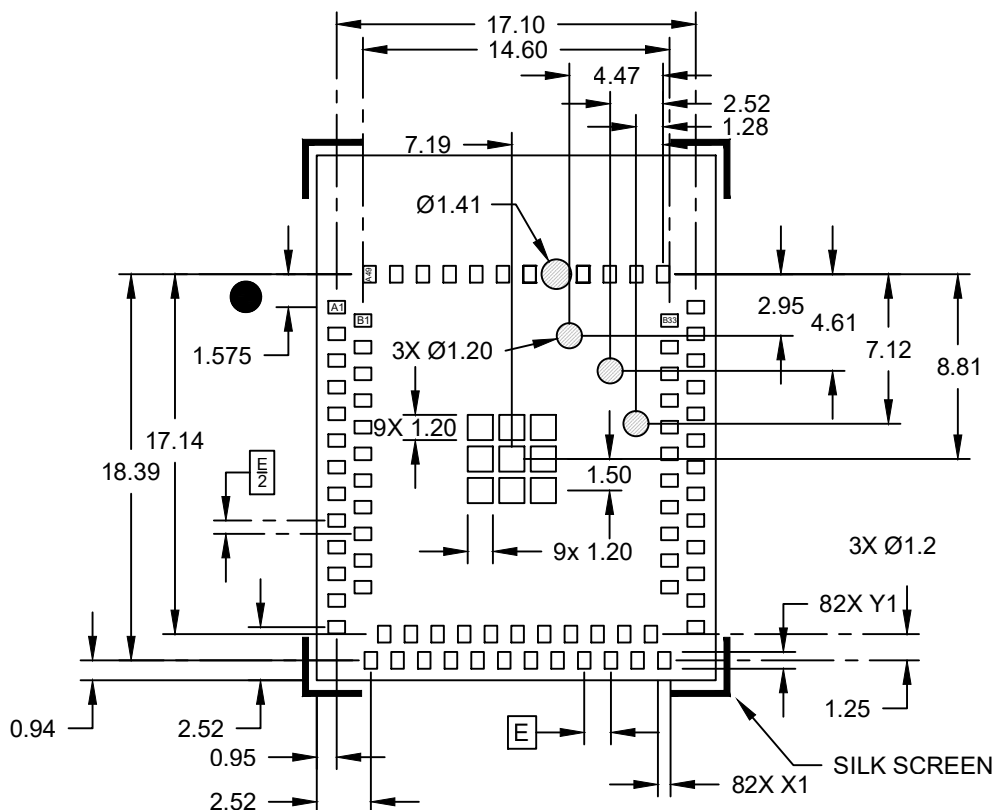


82L-PCB Module (6TW) - 19x25x2.75mm - [MODULE] with Metal Shield and Coaxial Connector

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Width (Xnn)	X1			0.70
Contact Pad Length (Xnn)	Y1			1.00



Copper Keep-Out Area for Test Point

Notes:

- Dimensioning and tolerancing per ASME Y14.5M
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- For best soldering results, please refer to IPC-7093.